

Title (en)

METHOD FOR PRODUCING AN ELECTRIC CONNECTION PART

Title (de)

VERFAHREN ZUM HERSTELLEN EINES ELEKTRISCHEN ANSCHLUSSTEILS

Title (fr)

PROCÉDÉ DE FABRICATION D'UN ÉLÉMENT DE CONNEXION ÉLECTRIQUE

Publication

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Application

**EP 15766792 A 20150917**

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Abstract (en)

[origin: WO2016087067A1] The invention relates to a method for producing an electric connection part in which an electric conductor (2) is provided. The electric conductor is provided such that a first conductor component and a second conductor component are bonded together; the electric conductor (2) is galvanically coated; a contact region (4) of the conductor (2) is exposed by removing the galvanic coating (6) using a radiation source (8); and the electric conductor (2) is provided in the form of a strip, wherein the strip (2) is at least partly separated into strip sections (20) before or after the coating process. The invention is also to provide a method which allows the removal of a galvanic coating (6), which is provided on the connection part (22), in an inexpensive and reliable manner in particular. According to the invention, this is achieved in that the galvanic coating (6) is removed in the contact region (4) using a radiation source (8).

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Citation (examination)

- US 2005103761 A1 20050519 - MIKI YASUNORI [JP], et al
- DE 10060917 A1 20020613 - INTEGRATED MAGNESIUM TECHNOLOG [SG], et al
- DE 10131225 A1 20020228 - TYCO ELECTRONICS AMP GMBH [DE]
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